

Edition: October/November 2014

Newsletter

Volume: 2



Preparations for ISPC 2015 are in full force. Updates are being made everyday to the website, exhibitor list, and there are a growing number of paper and presentation contributions. Make sure you are a part of ISPC 2015!



<http://psessymposium.org>

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Enjoy
Chicago's
Deep Dish
Pizza



Message from the Technical Program Co-Chairs

Hello Everyone,

As co-Chairs of the 2015 ISPCE Technical Program Committee (TPC) we would like to provide you with an update on the technical program planning for the 2015 ISPCE.

Your TPC is hard at work identifying prospective Authors & Presenters to prepare/submit topics and material for the 2015 Symposium that will be of interest to you as potential ISPCE attendees. We also are trying to encourage participation in the Symposium from all regions globally!

In addition to a variety of interesting tracks (listed on the next page), we also are targeting the following specialty topics due to their current prominence:

Wearable Technology
3D Printing & Additive Manufacturing
IEC 62368-1

We already have numerous Vendors and Patrons interested in ISPCE 2015 and signed up, so it's important we produce the best Technical Program possible.

If you are interested in being an Author/Presenter or Presenter, we encourage you to explore the ISPCE website, including the Author & Presenter page - <http://psessymposium.org/content/author-presenter-instructions>.

And remember, the first Author/Presenter Deadline is December 15, 2014, less than two months away!

For this first deadline, we are requesting submission of (a) Title, (b) Abstract, and (c) Reviewable Paper or Reviewable Presentation, depending on whether submitting as Author/Presenter or Presenter only. The submission of the material will be via the revamped/improved Editor's Assistant (EDAS) platform, and submitting the requested material by the first Author Deadline allows for more efficient handling of formal Paper peer reviews, Presentations reviews, circulation of TPC feedback to Authors & Presenters, selection of Papers/Presentations for the Program content, refinement of final Papers & Presentations and, just as important, advance circulation of the ISPCE Program content so potential Attendees can make their decisions early on whether to register and attend!

Remember for the 2014 ISPCE we had more Submissions than we could accommodate, so it's important to get your submissions in early and in accordance with the submission requirements so your important contributions can be fully considered for inclusion in the 2015 ISPCE Program.

The 2014 ISPCE was the most attended and well received ISPCE to date, and we are hoping to build upon this even more in 2015 in Chicago! Your participation as an Author/Presenter or Presenter is critical. If prospective Authors or Presenters have any questions on the ISPCE, please feel free to contact either Cynda Covert at Conference Catalysts, or one of the TPC Co-Chairs - Tom or Dwayne, or any one of the other TPC volunteers!

We are looking forward to your contributions to the 2015 ISPCE Technical Program, and are looking forward to seeing everyone in Chicago in May!

Thank you.

Tom Burke
2015 ISPCE TPC Co-Chair
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Dwayne Davis
2015 ISPCE TPC Co-Chair
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CALL FOR PAPERS, PRESENTATIONS, WORKSHOPS, AND TUTORIALS

<http://psessymposium.org>

We continue to seek out
Authors & Presenters for these
exciting subject matter areas!

- New to ISPCE- Compliance 101
(Track Chair: Dan Roman)
- EMC Compliance
- Energy Storage & Batteries
(Track Chair: Jan Swart)
- Failure Analysis & Forensics
(Track Chair: Daren Slee)
- Functional Safety
- Global Regulations & Certification Management
- Innovation
- Leadership
- Machinery
- Medical (Track Chair: Rich Gardner)
- Miscellaneous
- Privacy & Security
- Risk Analysis, Assessment, & Management
- Standards & Applications
- Safety Science, incl. Hazard-based Safety Engineering
(Track Chair: Tom Lanzisero)

We are honored to have such a diverse
group of volunteers representing almost
every region of the world!

The 2015 ISPCE TPC Members are as follows:

Co-Chairs:

Tom Burke (UL, USA)

Dwayne Davis (Associated Research, USA)

Daniece Carpenter (Dell, USA)

Luiz Claudio Araujo (Lindsay Corp., USA)

Flore Chiang (UL, Taiwan)

Ted Eckert (Microsoft, USA)

Richard Gardner (GE Healthcare, USA)

Tom Lanzisero (UL, USA)

S.L. Mak (Open University of Hong Kong, China)

Murlin Marks (USA)

Stefan Mozar (Australia)

Paul W. Robinson (IBM, Australia)

Dan Roman (Colgate Palmolive, USA)

Grant Schmidbauer (NEMKO, USA)

Daren Slee (Exponent, USA)

Jan Swart (Exponent, USA)

Paul Wang (G&M Compliance, China)

Dr. Susanne Wende LL. M. (Noerr LLP, Germany)

Important Dates

Review Formal Paper/Reviewable Presentation Submission: **December 15, 2014**

Acceptance Notification: **February 1, 2015**

Final Camera-ready Paper/Presentation Submission: **April 1, 2015**



Registration



Symposium registration includes access to all technical sessions, invited speakers, lunches, breakfasts, breaks, the reception, and one copy of the ISPCE 2015 Proceedings

Through April 1, 2015

After April 1, 2015

Registration Type

Advanced

Regular & On-site

IEEE Members

\$550

\$600

Non-Members

\$650

\$700

Student/IEEE Life Members

\$150

\$200

Online Registration opens soon

CALL FOR EXHIBITORS

The IEEE Product Safety Engineering Society invites your company to participate in their premier event, ISPCE 2015.

Signage • Program Ads • Complimentary Registrations • Literature



The Early Bird Special includes a Tote Bag promotional item. Secure your spot before January 1.

Pricing

<u>Tabletop before April 10</u>		<u>Tabletop after April 10</u>
First	\$800.00	\$1000.00
Additional	\$500.00	\$600.00

Contact

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Current Patrons & Exhibitors



ONE WORLD • OUR APPROVAL

